

2

SOD-323

Features:

- Planar Die Construction
- · General Purpose, Medium Current
- · Ideally Suited for Automated Assembly Processes

Applications:

- Zener diode
- · Ultra-small surface mount package

Maximum Rating @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward voltage @ I _F = 10mA	V _F	0.9	V
Power dissipation	Po	200	mW
Thermal resistance, junction to ambient air	R_{\thetajA}	625	°C/W
Junction temperature	T _j	150	°C
Storage temperature range	T _{stg}	-65 to +150	°C

Note Valid provided that device terminals are kept at ambient temperature. Short duration test pulse used in minimize self-heating effect. f = 1kHz.





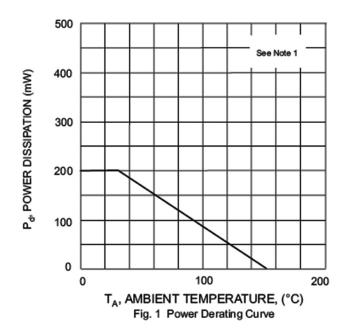


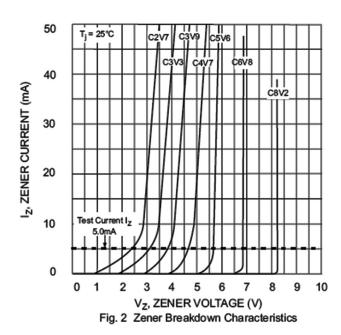
Electrical Characteristics @ TA = 25°C unless otherwise specified

T	No. of the con-	Zener Voltage Range				Maximum Zener Impedance		Maximum Reverse Current		Typical Temperature Coefficient@		
Type Number	Marking Code		V _z @I _{zt}		I _{zt}	Z _{zT} @I _{zT}	Z _{zK} @I _{zK}	l _{zk}	I _R	@V _R	I _{ztc} m	iV/°C
		Nom(V)	Min(V)	Max(V)	mA	Ω	Σ	mA	μΑ	V	Min	Max
BZT52C4V7S	W7	4.7	4.4	5	5	80	500	1	3	2	-3.5	0.2

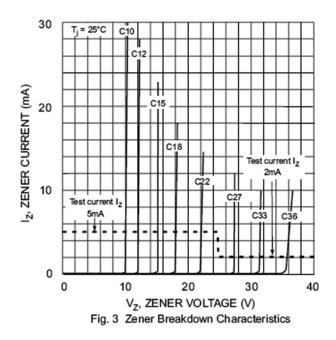
Note Valid provided that device terminals are kept at ambient temperature. Tested with pulses, period = 5ms, pulse width = 300μs. f = 1kHz.

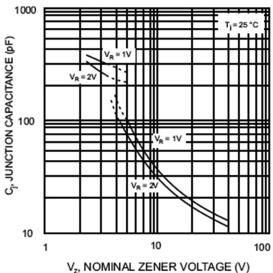
Typical Characteristics @ T_A = 25°C unless otherwise specified







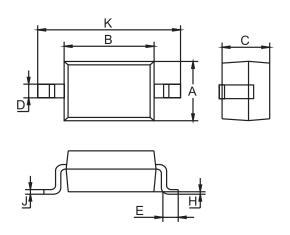




V_z, NOMINAL ZENER VOLTAGE (V) Fig. 4 Junction Capacitance vs Nominal Zener Voltage

Package Outline

Plastic surface mounted package



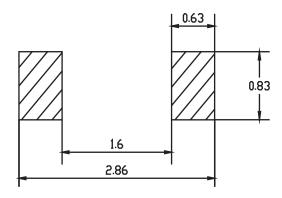
SOD-323				
Dim	Min	Max		
А	1.275	1.325		
В	1.675	1.725		
С	0.9 Typical			
D	0.25	0.35		
E	0.27	0.37		
Н	0.02	0.1		
J	0.1 Typical			
К	2.6	2.7		
All Dimensions in mm				

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Soldering Footprint



Dimensions: Millimetres

Package Information

Device	Package	Shipping
BZT52C4V7S-7-F	SOD-323	3,000/Tape & Reel

Part Number Table

Description	Part Number		
Surface Mount Zener Diode	BZT52C4V7S-7-F		

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